## TEMIC

# TV-Tuner-IC with Two Separate Oscillators and Mixers, SAW-Driver and Dual-State Band Switch

#### **Features**

- 9 V supply voltage
- Frequency range from 48 to 860 MHz
- Band A: balanced high impedance mixer input and amplitude controlled oscillator
- Band B: balanced low impedance mixer input and symmetrical oscillator
- SAW filter driver with low impedance output
- Voltage regulator for stable operating characteristics
- ESD protection on all pins except oscillator pins and RF-inputs

Package: SO20

## **Block Diagram**

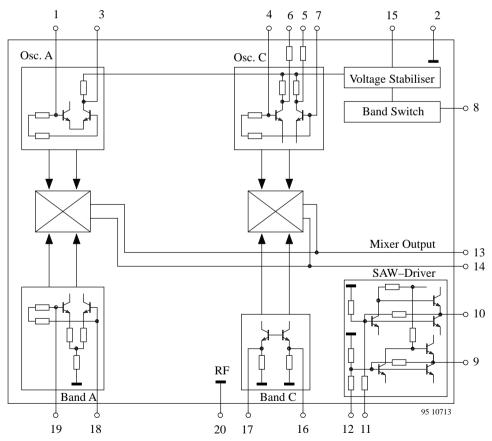
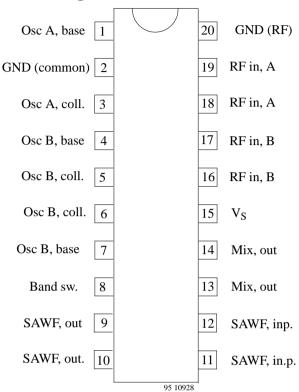


Figure 1. Block diagram pinning of U2329B

### **Pin Configuration**



Pin	Symbol	Function
1	Osc A, base	Oscillator band A, base
2	GND (common)	Ground, common
3	Osc A, coll.	Oscillator band A, collector
4, 7	Osc B, base	Oscillator band B, bases
5, 6	Osc B, coll.	Oscillator band B, collectors
8	Band sw.	Dual-state band switch
9, 10	SAWF, out	SAW filter driver outputs
11, 12	SAWF, inp.	SAW filter driver input
13, 14	Mix, out	Mixer outputs, open collector
15	$V_{S}$	Supply voltage V <sub>s</sub>
16, 17	RF in, B	RF inputs, band B
18, 19	RF in, A	RF inputs, band A
20	GND (RF)	Ground, RF part

## **Absolute Maximum Ratings**

All voltages are referred to GND, pin 2 (pin 19). Pin numbers in brackets for the mirrored version.

Parameters		Symbol	Min.	Тур.	Max.	Unit
Supply voltage	Pin 15	$V_{S}$			10.5	V
RF inputs	Pin 16-19				5.0	V
IF outputs	Pin 13-14				10.5	V
Dual-state switch voltage	Pin 8	ViDSW			10.5	V
Junction temperature		T <sub>jmax</sub>			125	°C
Storage temperature		T <sub>stg</sub>	-40		125	°C

## **Operating Range**

All voltages are referred to GND, pin 2 (pin 19). Pin numbers in brackets for the mirrored version.

Parameters	Test Conditions / Pins	Symbol	Min	Тур	Max	Unit
Supply voltage	Pin 13-15	$V_{S}$	8.1	9	9.9	V
Ambient temperature		T <sub>amb</sub>	-25		75	°C
Thermal resistance	Test conditions page	$R_{thJA}$		90		K/W

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#### **TELEFUNKEN Semiconductors**

#### **Electrical Characteristics**

Test conditions (unless otherwise specified):  $V_s = 9 \text{ V}$ .  $T_{amb} = 25 \text{ °C}$ . Reference point Pin 2

Parameters	Test Conditi	ons / Pins	Symbol	Min	Тур	Max	Unit
Supply voltage	Pin 13-15		$V_{S}$	8.1	9.0	9.9	V
Supply current		Pin 13-15	$I_S$		42		mA
Band switch							
Voltage Band A		Pin 8	VSWA	0	0	1.0	V
Voltage Band C		Pin 8	VSWC	3.4	4.0	5.0	V
Switching current	VSW = 5 V	Pin 8	ISW			100	μΑ
<b>SAW filter driver</b> fi = 36 M	Hz						
Input impedance		Pin 11, 12	ZiSAW		450		Ω
Output impedance		Pin 9, 10	ZoSAW		70		
Voltage gain	11, 12 →	Pin 9, 10	GvSAW		17		dB
Band A (note 1)							
Input frequency range		Pin 18	fiA	48		470	MHz
Input impedance	Figure 3	Pin 18	S11A				
Gain (note 4)	Pin I/P to O/P		GA		28		dB
Noise figure DSB (note 2):	Pin I/P to O/P						
	fiA = 50 MHz		NF NF		11.5		dB
	<del> </del>	fiA = 150 MHz			12		dB
<u> </u>	nput level for (note 3): Each carrier						
IM3 (interm. of 3rd order	fiA = 71 MHz	Pin I/P	ViA		-23		dBm
IM2 (interm. of 2nd order)	fiA = 71 MHz	Pin I/P	ViA		-22		dBm
Band B (note 1)	1				_		_
Input frequency range		Pin 16, 17	fiB	470		860	MHz
Input impedance	Figure 3	Pin 16, 17	S11B			8	
Gain (note 4)	Pin I/P to O/P		GB		32		dB
Noise figure DSB (note 2) Pin I/P to O/P							
	fiB = 500  MHZ		NF		10.5		dB
fiB = 800  MHz			NF		11.5		dB
<u> </u>	Input level for (note 3): Each carrier						
IM3 (interm. of 3rd order)	fiC = 600  MHz	Pin I/P	ViB		-25		dBm

#### Notes

The RF input B is symmetrical driven by means of a hybrid for  $180^{\circ}$  phase shifting, consequently the source impedance is  $100 \ \Omega$ . All other impedance for RF tests is  $50 \ \Omega$ .

The noise figure (NF) is the value for double-side-band measurement.

The intermodulation test (2-carrier-method) which is made on IF-centre is in reference to a signal-to-IM ratio of 60 dB.

Gain is the ratio of the voltage at the primary coil of L5 to the available voltage at the input.

#### **Test and Principle Application Circuit**

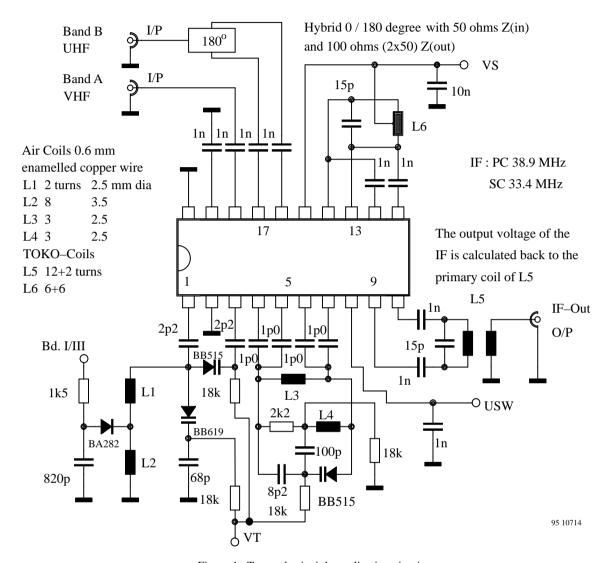


Figure 1. Test and principle application circuit

## PCB for the $R_{thJA}$ -Measurement

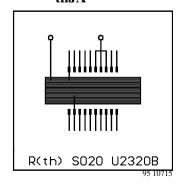


Figure 2. PCB for the  $R_{thja}$ -measurement

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### Input Impedance Mixer Band A (S11A) and B (S11B)

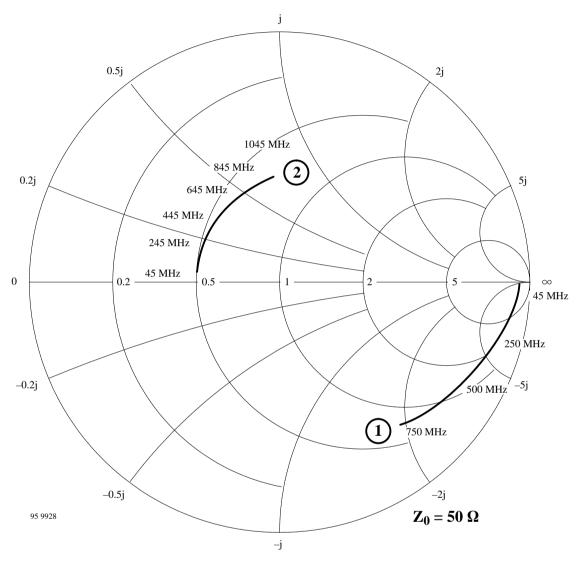


Figure 3. Input impedance mixer band A (S11A) and B (S11B)

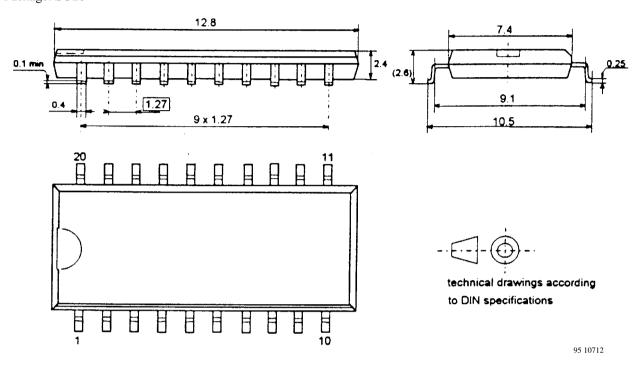
## VHF-Low Normalised to 50 $\Omega$ , measuring range 45 MHz to 750 MHz.

#### 2) VHF-High and UHF

Normalised to 50  $\Omega$ , measuring range 45 MHz to 1045 MHz. Input is driven symmetrical. The output impedance of hybrid is 100  $\Omega$ , the measured level is then calculated in reference to 50  $\Omega$ .

### **Dimensions in mm:**

Package: SO20



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#### **Ozone Depleting Substances Policy Statement**

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

TEMIC TELEFUNKEN microelectronic GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423